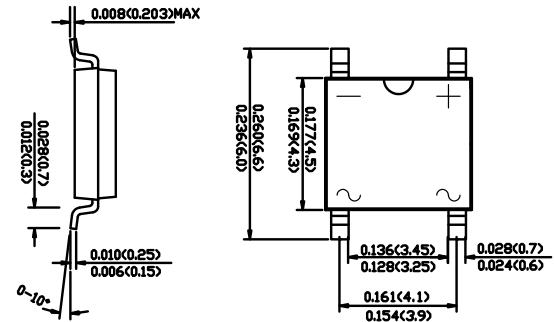


SINGLE PHASE GLASS PASSIVATED BRIDGE RECTIFIERS

Features

- ◆ Ideal for printed circuit board
- ◆ Reliable low cost construction utilizing molded plastic technique
- ◆ High temperature soldering guaranteed: 260°/10 seconds at 5 lbs., (2.3kg) tension
- ◆ Small size, simple installation
- ◆ High surge current capability

ABS **ROHS**
COMPLIANT



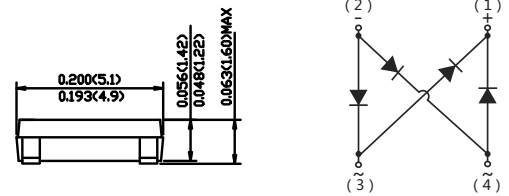
Mechanical Data

Case : JEDEC ABS Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	MDD	MDD	MDD	MDD	MDD	UNITS	
		ABS22	ABS24	ABS26	ABS28	ABS210		
Marking Code								
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V	
Maximum RMS voltage	V_{RMS}	140	280	420	560	700	V	
Maximum DC blocking voltage	V_{DC}	200	400	600	800	1000	V	
Maximum average forward rectified current	$I_{F(AV)}$	2.0						A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	50						A
Maximum instantaneous forward voltage drop per leg at 2.0A	V_F	1.0						V
Rating for Fusing($t < 8.3ms$)	I^2t	10.375						A ² s
Maximum DC reverse current at rated DC blocking voltage	I_R	$T_A = 25^\circ C$					5.0	uA
		$T_A = 125^\circ C$					100	uA
Typical thermal resistance(NOTE1)	$R_{\theta JA}$	60						°C/W
	$R_{\theta JC}$	16						
Typical thermal capacitance(NOTE2)	C_J	25						pF
Operating temperature range	T_J	-55 to +150						°C
storage temperature range	T_{STG}	-55 to +150						°C

Note: 1. Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.

2. Measured at 1MHz and applied reverse voltage of 4 V D.C.

Ratings And Characteristic Curves

Fig.1 Average Rectified Output Current Derating Curve

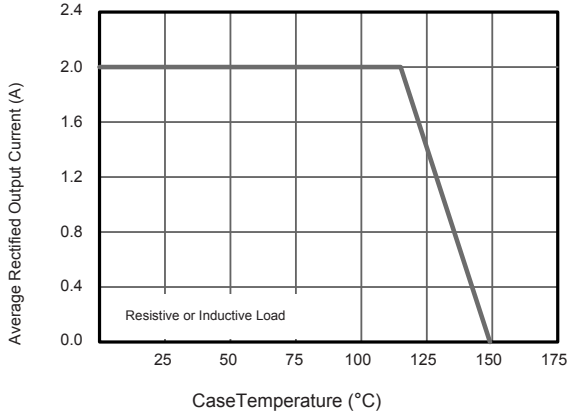


Fig.2 Typical Reverse Characteristics

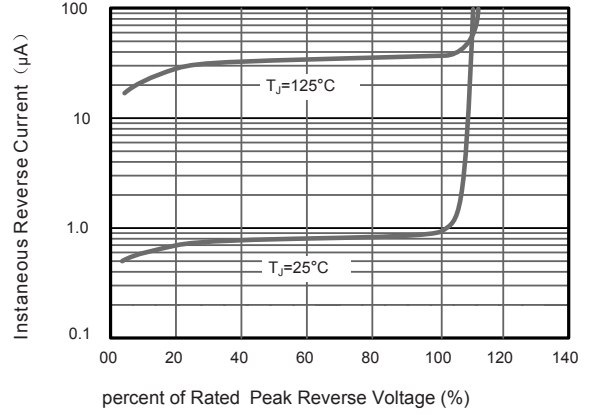


Fig.3 Typical Instantaneous Forward Characteristics T_J=25°

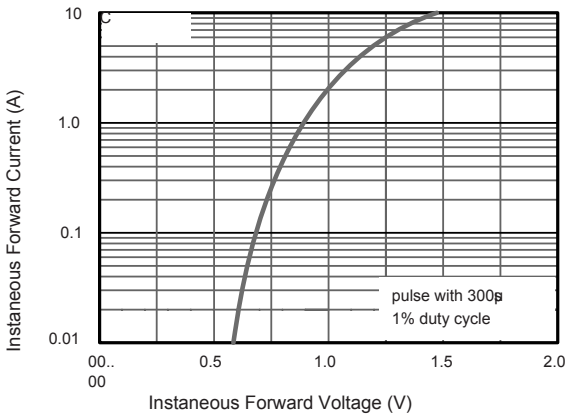


Fig.4 Typical Junction Capacitance

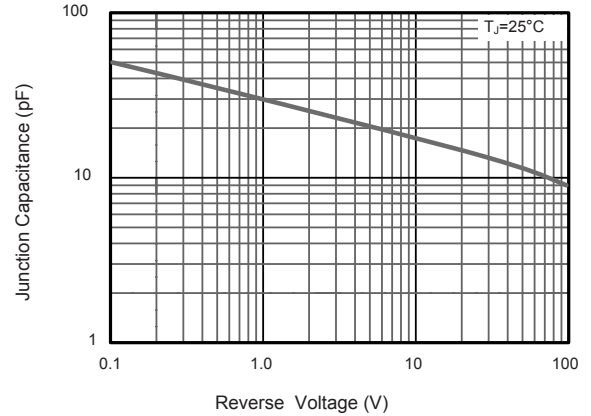
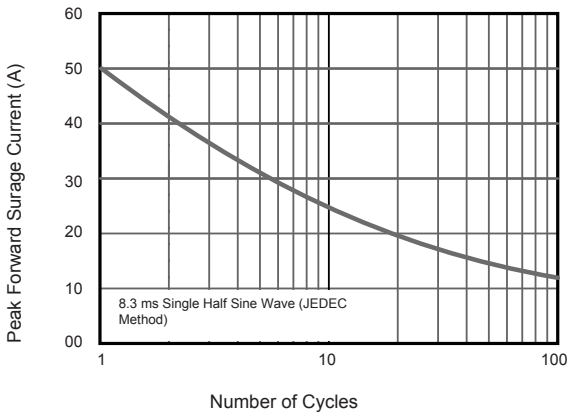
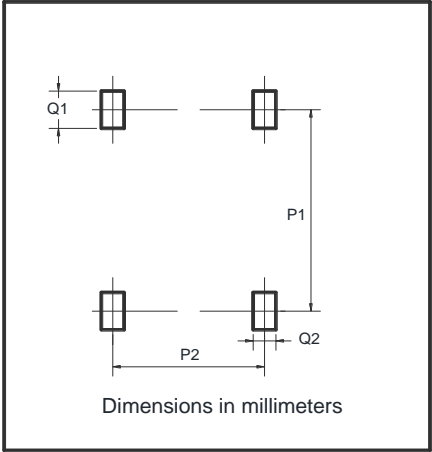


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



The curve above is for reference only.

Suggested Pad Layout



Dim	Min
P1	5.72
P2	4.00
Q1	1.00
Q2	0.90